## 1. General description

The NX3L1T5157 is a low-ohmic single-pole double-throw analog switch suitable for use as an analog or digital 2:1 multiplexer/demultiplexer. It has a digital select input (S), two independent inputs/outputs ( Y 0 and Y 1 ) and a common input/output ( Z ).

Schmitt trigger action at the digital input makes the circuit tolerant to slower input rise and fall times. Low threshold digital input allows this device to be driven by 1.8 V logic levels in 3.3 V applications without significant increase in supply current I cc . This makes it possible for the NX3L1T5157 to switch 4.3 V signals with a 1.8 V digital controller, eliminating the need for logic level translation. The NX3L1T5157 allows signals with amplitude up to $\mathrm{V}_{\mathrm{CC}}$ to be transmitted from $Z$ to Y 0 or Y 1 , or from Y 0 or Y 1 to Z . Its low ON resistance ( $0.5 \Omega$ ) and flatness $(0.13 \Omega)$ ensures minimal attenuation and distortion of transmitted signals.

## 2. Features and benefits

Wide supply voltage range from 1.4 V to 4.3 V

- Very low ON resistance (peak):
- $1.6 \Omega$ (typical) at $\mathrm{V}_{\mathrm{Cc}}=1.4 \mathrm{~V}$
- $1.0 \Omega$ (typical) at $\mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$
- $0.55 \Omega$ (typical) at $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$
- $0.50 \Omega$ (typical) at $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$
- $0.50 \Omega$ (typical) at $\mathrm{V}_{\mathrm{CC}}=4.3 \mathrm{~V}$
- Break-before-make switching
- High noise immunity
- ESD protection:
- HBM JESD22-A114F Class 3A exceeds 7500 V
- MM JESD22-A115-A exceeds 200 V
- CDM AEC-Q100-011 revision B exceeds 1000 V
- IEC61000-4-2 contact discharge exceeds 8000 V for switch ports
- CMOS low-power consumption

■ Latch-up performance exceeds 100 mA per JESD78 Class II Level A

- 1.8 V control logic at $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}$
- Control input accepts voltages above supply voltage
- Very low supply current, even when input is below $\mathrm{V}_{\mathrm{Cc}}$

■ High current handling capability ( 350 mA continuous current under 3.3 V supply)

- Specified from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ and from $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$


## 3. Applications

- Cell phone
- PDA
- Portable media player


## 4. Ordering information

Table 1. Ordering information

| Type number | Topside <br> marking $\underline{[1]}]$ | Package | Name | Description | Version |
| :--- | :--- | :--- | :--- | :--- | :--- |
|  | NX3L1T5157GM | DI | XSON6 | plastic extremely thin small outline package; no leads; 6 <br> terminals; body $1 \times 1.45 \times 0.5 \mathrm{~mm}$ | SOT886 |

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

### 4.1 Ordering options

Table 2. Ordering options

| Type number | Orderable <br> part number | Package | Packing method | Minimum <br> order quantity | Temperature |
| :--- | :--- | :--- | :--- | :--- | :--- |
| NX3L1T5157GM | NX3L1T5157GM,115[1] | XSON6 | REEL 7" Q1 NDP | 5000 | $\mathrm{~T}_{\mathrm{amb}}=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| NX3L1T5157GM | NX3L1T5157GM,132[1] | XSON6 | REEL 7" Q3 NDP | 5000 | $\mathrm{~T}_{\mathrm{amb}}=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| NX3L1T5157GM | NX3L1T5157GMZ | XSON6 | REEL 7" Q1 NDP <br> SSB[2] | 5000 | $\mathrm{~T}_{\mathrm{amb}}=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| NX3L1T5157GM | NX3L1T5157GMAZ | XSON6 | REEL 7" Q3 NDP <br> SSB[2] | 5000 | $\mathrm{~T}_{\mathrm{amb}}=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |

[1] Will go EOL - migrate to new leadframe orderable part number.
[2] This packing method uses a Static Shielding Bag (SSB) solution. Material is to be kept in the sealed bag between uses.

## 5. Functional diagram



Fig 1. Logic symbol


Fig 2. Logic diagram

## 6. Pinning information

### 6.1 Pinning



Fig 3. Pin configuration SOT886 (XSON6)

### 6.2 Pin description

Table 3. Pin description

| Symbol | Pin | Description |
| :--- | :--- | :--- |
| S | 1 | select input |
| VCC | 2 | supply voltage |
| Z | 3 | common input or output |
| Y0 | 4 | independent input or output |
| GND | 5 | ground (0 V) |
| Y1 | 6 | independent input or output |

## 7. Functional description

Table 4. Function table [1]

| Input S | Channel on |
| :--- | :--- |
| L | Y0 |
| H | Y1 |

[1] $\mathrm{H}=$ HIGH voltage level; $\mathrm{L}=$ LOW voltage level.

## 8. Limiting values

Table 5. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions |  | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{Cc}}$ | supply voltage |  |  | -0.5 | +4.6 | V |
| $V_{1}$ | input voltage | select input S | [1] | -0.5 | +4.6 | V |
| $\mathrm{V}_{\text {SW }}$ | switch voltage |  | [2] | -0.5 | $\mathrm{V}_{\mathrm{CC}}+0.5$ | V |
| $\mathrm{I}_{\mathrm{IK}}$ | input clamping current | $\mathrm{V}_{1}<-0.5 \mathrm{~V}$ |  | -50 | - | mA |
| $\mathrm{ISK}^{\text {K }}$ | switch clamping current | $\mathrm{V}_{1}<-0.5 \mathrm{~V}$ or $\mathrm{V}_{1}>\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$ |  | - | $\pm 50$ | mA |
| Isw | switch current | $\mathrm{V}_{\mathrm{SW}}>-0.5 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{SW}}<\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$ source or sink current |  | - | $\pm 350$ | mA |
|  |  | $\mathrm{V}_{\mathrm{SW}}>-0.5 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{SW}}<\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V} \text {; }$ <br> pulsed at 1 ms duration, < $10 \%$ duty cycle; peak current |  | - | $\pm 500$ | mA |
| $\mathrm{T}_{\text {stg }}$ | storage temperature |  |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{P}_{\text {tot }}$ | total power dissipation | $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+125{ }^{\circ} \mathrm{C}$ | [3] | - | 250 | mW |

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.
[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V .
[3] For XSON6 package: above $118^{\circ} \mathrm{C}$ the value of $\mathrm{P}_{\text {tot }}$ derates linearly with $7.8 \mathrm{~mW} / \mathrm{K}$.

## 9. Recommended operating conditions

Table 6. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Max | Unit |
| :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathrm{V}_{\mathrm{CC}}$ | supply voltage |  | 1.4 | 4.3 | V |
| $\mathrm{~V}_{\mathrm{I}}$ | input voltage | select input S | 0 | 4.3 | V |
| $\mathrm{~V}_{\mathrm{SW}}$ | switch voltage |  | $[1]$ | 0 | $\mathrm{~V}_{\mathrm{CC}}$ |
| $\mathrm{T}_{\mathrm{amb}}$ | ambient temperature |  | -40 | V |  |
| $\Delta \mathrm{t} / \Delta \mathrm{V}$ | input transition rise and fall rate | $\mathrm{V}_{\mathrm{CC}}=1.4 \mathrm{~V}$ to 4.3 V | $[2]$ | - | 200 |

[1] To avoid sinking GND current from terminal $Z$ when switch current flows in terminal $Y n$, the voltage drop across the bidirectional switch must not exceed 0.4 V . If the switch current flows into terminal Z , no GND current will flow from terminal Yn . In this case, there is no limit for the voltage drop across the switch.
[2] Applies to control signal levels.

## 10. Static characteristics

Table 7. Static characteristics
At recommended operating conditions; voltages are referenced to GND (ground 0 V ).

| Symbol | Parameter | Conditions | $\mathrm{T}_{\text {amb }}=25^{\circ} \mathrm{C}$ |  |  | $\mathrm{T}_{\mathrm{amb}}=-40^{\circ} \mathrm{C}$ to +125 ${ }^{\circ} \mathrm{C}$ |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max | Min | $\begin{gathered} \operatorname{Max} \\ \left(85^{\circ} \mathrm{C}\right) \end{gathered}$ | $\begin{gathered} \operatorname{Max} \\ \left(125{ }^{\circ} \mathrm{C}\right) \end{gathered}$ |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH-level input voltage | $\mathrm{V}_{\mathrm{CC}}=1.4 \mathrm{~V}$ to 1.6 V | 0.9 | - | - | 0.9 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ to 1.95 V | 0.9 | - | - | 0.9 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ to 2.7 V | 1.1 | - | - | 1.1 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to 3.6 V | 1.3 | - | - | 1.3 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}$ to 4.3 V | 1.4 | - | - | 1.4 | - | - | V |
| $\mathrm{V}_{\text {IL }}$ | LOW-level input voltage | $\mathrm{V}_{\mathrm{CC}}=1.4 \mathrm{~V}$ to 1.6 V | - | - | 0.3 | - | 0.3 | 0.3 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ to 1.95 V | - | - | 0.4 | - | 0.4 | 0.3 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ to 2.7 V | - | - | 0.4 | - | 0.4 | 0.4 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to 3.6 V | - | - | 0.5 | - | 0.5 | 0.5 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}$ to 4.3 V | - | - | 0.6 | - | 0.6 | 0.6 | V |
| 1 | input leakage current | select input S; $\begin{aligned} & \mathrm{V}_{1}=\mathrm{GND} \text { to } 4.3 \mathrm{~V} ; \\ & \mathrm{V}_{\mathrm{CC}}=1.4 \mathrm{~V} \text { to } 4.3 \mathrm{~V} \end{aligned}$ | - | - | - | - | $\pm 0.5$ | $\pm 1$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {S(OFF) }}$ | OFF-state leakage current | Y0 and Y1 port; see Figure 4 |  |  |  |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.4 \mathrm{~V}$ to 3.6 V | - | - | $\pm 5$ | - | $\pm 50$ | $\pm 500$ | nA |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}$ to 4.3 V | - | - | $\pm 10$ | - | $\pm 50$ | $\pm 500$ | nA |
| $\mathrm{IS}_{\text {(ON })}$ | ON-state leakage current | Z port; see Figure 5 |  |  |  |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.4 \mathrm{~V}$ to 3.6 V | - | - | $\pm 5$ | - | $\pm 50$ | $\pm 500$ | nA |
|  |  | $\mathrm{V}_{\text {CC }}=3.6 \mathrm{~V}$ to 4.3 V | - | - | $\pm 10$ | - | $\pm 50$ | $\pm 500$ | nA |
| ICC | supply current | $\begin{aligned} & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{Cc}} \text { or } \mathrm{GND} ; \\ & \mathrm{V}_{\mathrm{SW}}=\mathrm{GND} \text { or } \mathrm{V}_{\mathrm{CC}} \end{aligned}$ |  |  |  |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}$ | - | - | 100 | - | 690 | 6000 | nA |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.3 \mathrm{~V}$ | - | - | 150 | - | 800 | 7000 | nA |
| $\Delta \mathrm{l}_{\text {CC }}$ | additional supply current | $\mathrm{V}_{\text {SW }}=\mathrm{GND}$ or $\mathrm{V}_{\mathrm{CC}}$ |  |  |  |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{I}}=2.6 \mathrm{~V} ; \mathrm{V}_{\mathrm{CC}}=4.3 \mathrm{~V}$ | - | 2.0 | 4.0 | - | 7 | 7 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{1}=2.6 \mathrm{~V} ; \mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}$ | - | 0.35 | 0.7 | - | 1 | 1 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{I}}=1.8 \mathrm{~V} ; \mathrm{V}_{C C}=4.3 \mathrm{~V}$ | - | 7.0 | 10.0 | - | 15 | 15 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{I}}=1.8 \mathrm{~V} ; \mathrm{V}_{C C}=3.6 \mathrm{~V}$ | - | 2.5 | 4.0 | - | 5 | 5 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{I}}=1.8 \mathrm{~V} ; \mathrm{V}_{\mathrm{CC}}=2.5 \mathrm{~V}$ | - | 50 | 200 | - | 300 | 500 | nA |
| $\mathrm{C}_{1}$ | input capacitance |  | - | 1.0 | - | - | - | - | pF |
| $\mathrm{C}_{\text {S(OFF) }}$ | OFF-state capacitance |  | - | 35 | - | - | - | - | pF |
| $\mathrm{C}_{\mathrm{S}(\mathrm{ON})}$ | ON-state capacitance |  | - | 130 | - | - | - | - | pF |

### 10.1 Test circuits


$\mathrm{V}_{\mathrm{I}}=0.3 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{CC}}-0.3 \mathrm{~V} ; \mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}}-0.3 \mathrm{~V}$ or 0.3 V .
Fig 4. Test circuit for measuring OFF-state leakage current

$\mathrm{V}_{\mathrm{I}}=0.3 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{CC}}-0.3 \mathrm{~V} ; \mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{Cc}}-0.3 \mathrm{~V}$ or 0.3 V .
Fig 5. Test circuit for measuring ON -state leakage current

### 10.2 ON resistance

Table 8. ON resistance
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 7 to Figure 13.

| Symbol | Parameter | Conditions | $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+85{ }^{\circ} \mathrm{C}$ |  |  | $\mathrm{T}_{\mathrm{amb}}=-40^{\circ} \mathrm{C}$ to +125 ${ }^{\circ} \mathrm{C}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ[1] | Max | Min | Max |  |
| $\mathrm{R}_{\text {ON( } \text { (peak) }}$ | ON resistance (peak) | $\begin{aligned} & \mathrm{V}_{1}=\mathrm{GND} \text { to } \mathrm{V}_{\mathrm{CC}} ; \\ & \mathrm{I}_{\mathrm{Sw}}=100 \mathrm{~mA} ; \text { see Figure } 6 \end{aligned}$ |  |  |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.4 \mathrm{~V}$ | - | 1.6 | 3.7 | - | 4.1 | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ | - | 1.0 | 1.6 | - | 1.7 | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ | - | 0.55 | 0.8 | - | 0.9 | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | - | 0.5 | 0.75 | - | 0.9 | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.3 \mathrm{~V}$ | - | 0.5 | 0.75 | - | 0.9 | $\Omega$ |

Table 8. ON resistance ...continued
At recommended operating conditions; voltages are referenced to GND (ground = 0 V ); for graphs see Figure 7 to Figure 13.

| Symbol | Parameter | Conditions | $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+85{ }^{\circ} \mathrm{C}$ |  |  | $\mathrm{T}_{\mathrm{amb}}=-40^{\circ} \mathrm{C}$ to +125 ${ }^{\circ} \mathrm{C}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ[1] | Max | Min | Max |  |
| $\Delta \mathrm{R}_{\mathrm{ON}}$ | ON resistance mismatch between channels | $\begin{aligned} & \mathrm{V}_{\mathrm{I}}=\mathrm{GND} \text { to } \mathrm{V}_{\mathrm{CC}} ; \\ & \mathrm{I}_{\mathrm{sw}}=100 \mathrm{~mA} \end{aligned}$ |  |  |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.4 \mathrm{~V}$ | - | 0.04 | 0.3 | - | 0.3 | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ | - | 0.04 | 0.2 | - | 0.3 | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ | - | 0.02 | 0.08 | - | 0.1 | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | - | 0.02 | 0.075 | - | 0.1 | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.3 \mathrm{~V}$ | - | 0.02 | 0.075 | - | 0.1 | $\Omega$ |
| $\mathrm{R}_{\text {ON(flat) }}$ | ON resistance (flatness) | $\begin{aligned} & \mathrm{V}_{\mathrm{I}}=\mathrm{GND} \text { to } \mathrm{V}_{\mathrm{Cc}} ; \\ & \mathrm{I}_{\mathrm{sw}}=100 \mathrm{~mA} \end{aligned}$ |  |  |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.4 \mathrm{~V}$ | - | 1.0 | 3.3 | - | 3.6 | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ | - | 0.5 | 1.2 | - | 1.3 | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ | - | 0.15 | 0.3 | - | 0.35 | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | - | 0.13 | 0.3 | - | 0.35 | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.3 \mathrm{~V}$ | - | 0.2 | 0.4 | - | 0.45 | $\Omega$ |

[1] Typical values are measured at $\mathrm{T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$.
[2] Measured at identical $\mathrm{V}_{\mathrm{Cc}}$, temperature and input voltage.
[3] Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical $\mathrm{V}_{\mathrm{CC}}$ and temperature.

### 10.3 ON resistance test circuit and graphs



Fig 6. Test circuit for measuring ON resistance

(1) $\mathrm{V}_{\mathrm{CC}}=1.5 \mathrm{~V}$.
(2) $\mathrm{V}_{\mathrm{CC}}=1.8 \mathrm{~V}$.
(3) $\mathrm{V}_{\mathrm{CC}}=2.5 \mathrm{~V}$.
(4) $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$.
(5) $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$.
(6) $\mathrm{V}_{\mathrm{Cc}}=4.3 \mathrm{~V}$.

Measured at $\mathrm{T}_{\text {amb }}=25^{\circ} \mathrm{C}$.
Fig 7. Typical ON resistance as a function of input voltage

(1) $\mathrm{T}_{\mathrm{amb}}=125^{\circ} \mathrm{C}$.
(2) $\mathrm{T}_{\mathrm{amb}}=85^{\circ} \mathrm{C}$.
(3) $\mathrm{T}_{\text {amb }}=25^{\circ} \mathrm{C}$.
(4) $\mathrm{T}_{\mathrm{amb}}=-40^{\circ} \mathrm{C}$.

Fig 8. ON resistance as a function of input voltage; $\mathrm{V}_{\mathrm{cc}}=1.5 \mathrm{~V}$

(1) $\mathrm{T}_{\mathrm{amb}}=125^{\circ} \mathrm{C}$.
(2) $\mathrm{T}_{\mathrm{amb}}=85^{\circ} \mathrm{C}$.
(3) $\mathrm{T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$.
(4) $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$.

Fig 10. ON resistance as a function of input voltage; $\mathrm{V}_{\mathrm{Cc}}=2.5 \mathrm{~V}$

(1) $\mathrm{T}_{\mathrm{amb}}=125^{\circ} \mathrm{C}$.
(2) $\mathrm{T}_{\text {amb }}=85^{\circ} \mathrm{C}$.
(3) $\mathrm{T}_{\text {amb }}=25^{\circ} \mathrm{C}$.
(4) $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$.

Fig 11. ON resistance as a function of input voltage; $\mathrm{V}_{\mathrm{Cc}}=2.7 \mathrm{~V}$

(1) $\mathrm{T}_{\mathrm{amb}}=125^{\circ} \mathrm{C}$.
(2) $\mathrm{T}_{\mathrm{amb}}=85^{\circ} \mathrm{C}$.
(3) $\mathrm{T}_{\text {amb }}=25^{\circ} \mathrm{C}$.
(4) $\mathrm{T}_{\mathrm{amb}}=-40^{\circ} \mathrm{C}$.

Fig 12. ON resistance as a function of input voltage; $\mathrm{V}_{\mathrm{cc}}=3.3 \mathrm{~V}$

(1) $\mathrm{T}_{\mathrm{amb}}=125^{\circ} \mathrm{C}$.
(2) $\mathrm{T}_{\text {amb }}=85^{\circ} \mathrm{C}$.
(3) $\mathrm{T}_{\text {amb }}=25^{\circ} \mathrm{C}$.
(4) $\mathrm{T}_{\mathrm{amb}}=-40^{\circ} \mathrm{C}$.

Fig 13. ON resistance as a function of input voltage;

$$
\mathrm{V}_{\mathrm{cc}}=4.3 \mathrm{~V}
$$

## 11. Dynamic characteristics

Table 9. Dynamic characteristics
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 16.

| Symbol | Parameter | Conditions | $25^{\circ} \mathrm{C}$ |  |  | $-40{ }^{\circ} \mathrm{C}$ to +125 ${ }^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ [1] | Max | Min | $\begin{gathered} \operatorname{Max} \\ \left(85{ }^{\circ} \mathrm{C}\right) \end{gathered}$ | $\begin{gathered} \operatorname{Max} \\ \left(125^{\circ} \mathrm{C}\right) \end{gathered}$ |  |
| ten | enable time | S to Z or Yn ; see Figure 14 |  |  |  |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.4 \mathrm{~V}$ to 1.6 V | - | 50 | 90 | - | 120 | 120 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ to 1.95 V | - | 36 | 70 | - | 80 | 90 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ to 2.7 V | - | 24 | 45 | - | 50 | 55 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to 3.6 V | - | 22 | 40 | - | 45 | 50 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}$ to 4.3 V | - | 22 | 40 | - | 45 | 50 | ns |
| $\mathrm{t}_{\text {dis }}$ | disable time | S to Z or Yn ; see Figure 14 |  |  |  |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.4 \mathrm{~V}$ to 1.6 V | - | 32 | 70 | - | 80 | 90 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ to 1.95 V | - | 20 | 55 | - | 60 | 65 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ to 2.7 V | - | 12 | 25 | - | 30 | 35 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to 3.6 V | - | 10 | 20 | - | 25 | 30 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}$ to 4.3 V | - | 10 | 20 | - | 25 | 30 | ns |

Table 9. Dynamic characteristics ...continued
At recommended operating conditions; voltages are referenced to GND (ground = 0 V ); for load circuit see Figure 16.

| Symbol | Parameter | Conditions | $25^{\circ} \mathrm{C}$ |  |  | $-40{ }^{\circ} \mathrm{C}$ to +125 ${ }^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ [1] | Max | Min | $\begin{gathered} \operatorname{Max} \\ \left(85^{\circ} \mathrm{C}\right) \end{gathered}$ | $\begin{gathered} \operatorname{Max} \\ \left(125^{\circ} \mathrm{C}\right) \end{gathered}$ |  |
| $\mathrm{t}_{\mathrm{b}-\mathrm{m}}$ | break-before-make time | see Figure 15 [2] |  |  |  |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.4 \mathrm{~V}$ to 1.6 V | - | 19 | - | 9 | - | - | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.65 \mathrm{~V}$ to 1.95 V | - | 17 | - | 7 | - | - | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ to 2.7 V | - | 13 | - | 4 | - | - | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to 3.6 V | - | 10 | - | 3 | - | - | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}$ to 4.3 V | - | 10 | - | 2 | - | - | ns |

[1] Typical values are measured at $\mathrm{T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{CC}}=1.5 \mathrm{~V}, 1.8 \mathrm{~V}, 2.5 \mathrm{~V}, 3.3 \mathrm{~V}$ and 4.3 V respectively.
[2] Break-before-make guaranteed by design.

### 11.1 Waveform and test circuits



Measurement points are given in Table 10
Logic level: $\mathrm{V}_{\mathrm{OH}}$ is typical output voltage level that occurs with the output load.
Fig 14. Enable and disable times

Table 10. Measurement points

| Supply voltage | Input | Output |
| :--- | :--- | :--- |
| $\mathbf{V}_{\mathrm{CC}}$ | $\mathbf{V}_{\mathbf{M}}$ | $\mathbf{V}_{\mathbf{X}}$ |
| 1.4 V to 4.3 V | $0.5 \mathrm{~V}_{\mathrm{CC}}$ | $0.9 \mathrm{~V}_{\mathrm{OH}}$ |


a. Test circuit

b. Input and output measurement points

Fig 15. Test circuit for measuring break-before-make timing


Test data is given in Table 11.
Definitions test circuit:
$R_{L}=$ Load resistance.
$C_{L}=$ Load capacitance including jig and probe capacitance.
$\mathrm{V}_{\mathrm{EXT}}=$ External voltage for measuring switching times.
Fig 16. Load circuit for switching times

Table 11. Test data

| Supply voltage | Input | Load |  |  |
| :--- | :--- | :--- | :--- | :--- |
| $\mathbf{V}_{\mathbf{C C}}$ | $\mathbf{V}_{\mathbf{I}}$ | $\mathbf{t}_{\mathbf{r}}, \mathbf{t}_{\mathbf{f}}$ | $\mathbf{C}_{\mathbf{L}}$ | $\mathbf{R}_{\mathbf{L}}$ |
| 1.4 V to 4.3 V | $\mathrm{~V}_{\mathrm{CC}}$ | $\leq 2.5 \mathrm{~ns}$ | 35 pF | $50 \Omega$ |

### 11.2 Additional dynamic characteristics

Table 12. Additional dynamic characteristics
At recommended operating conditions; voltages are referenced to GND (ground $=0 \mathrm{~V}$ ); $V_{l}=G N D$ or $V_{C C}$ (unless otherwise specified); $t_{r}=t_{f} \leq 2.5 \mathrm{~ns} ; T_{\text {amb }}=25^{\circ} \mathrm{C}$.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| THD | total harmonic distortion | $\mathrm{f}_{\mathrm{i}}=20 \mathrm{~Hz}$ to $20 \mathrm{kHz} ; \mathrm{R}_{\mathrm{L}}=32 \Omega$; see Figure 17 [1] |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.4 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=1 \mathrm{~V}(\mathrm{p}-\mathrm{p})$ | - | 0.15 | - | \% |
|  |  | $\mathrm{V}_{C C}=1.65 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=1.2 \mathrm{~V}$ (p-p) | - | 0.10 | - | \% |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=1.5 \mathrm{~V}(\mathrm{p}-\mathrm{p})$ | - | 0.02 | - | \% |
|  |  | $\mathrm{V}_{C C}=2.7 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=2 \mathrm{~V}(\mathrm{p}-\mathrm{p})$ | - | 0.02 | - | \% |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.3 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=2 \mathrm{~V}(\mathrm{p}-\mathrm{p})$ | - | 0.02 | - | \% |
| $\mathrm{f}_{(-3 \mathrm{~dB})}$ | -3 dB frequency response | $\mathrm{R}_{\mathrm{L}}=50 \Omega$; see Figure 18 [1] |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.4 \mathrm{~V}$ to 4.3 V | - | 60 | - | MHz |
| $\alpha_{\text {iso }}$ | isolation (OFF-state) | $\mathrm{f}_{\mathrm{i}}=100 \mathrm{kHz} ; \mathrm{R}_{\mathrm{L}}=50 \Omega$; see $\underline{\text { Figure } 19}$ |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.4 \mathrm{~V}$ to 4.3 V | - | -90 | - | dB |
| $\mathrm{V}_{\mathrm{ct}}$ | crosstalk voltage | between digital inputs and switch; $\mathrm{f}_{\mathrm{i}}=1 \mathrm{MHz} ; \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF} ; \mathrm{R}_{\mathrm{L}}=50 \Omega$; see Figure 20 |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.4 \mathrm{~V}$ to 3.6 V | - | 0.2 | - | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}$ to 4.3 V | - | 0.3 | - | V |
| $\mathrm{Q}_{\text {inj }}$ | charge injection | $\begin{aligned} & \mathrm{f}_{\mathrm{i}}=1 \mathrm{MHz} ; \mathrm{C}_{\mathrm{L}}=0.1 \mathrm{nF} ; \mathrm{R}_{\mathrm{L}}=1 \mathrm{M} \Omega ; \mathrm{V}_{\text {gen }}=0 \mathrm{~V} \text {; } \\ & \mathrm{R}_{\text {gen }}=0 \Omega ; \text { see Figure } 21 \end{aligned}$ |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.5 \mathrm{~V}$ | - | 3 | - | pC |
|  |  | $\mathrm{V}_{\mathrm{CC}}=1.8 \mathrm{~V}$ | - | 4 | - | pC |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.5 \mathrm{~V}$ | - | 6 | - | pC |
|  |  | $\mathrm{V}_{\mathrm{Cc}}=3.3 \mathrm{~V}$ | - | 9 | - | pC |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.3 \mathrm{~V}$ | - | 15 | - | pC |

[1] $f_{i}$ is biased at $0.5 \mathrm{~V}_{\mathrm{Cc}}$.

### 11.3 Test circuits



Fig 17. Test circuit for measuring total harmonic distortion


Adjust $f_{i}$ voltage to obtain 0 dBm level at output. Increase $\mathrm{f}_{\mathrm{i}}$ frequency until dB meter reads -3 dB .
Fig 18. Test circuit for measuring the frequency response when channel is in ON-state


Adjust $f_{i}$ voltage to obtain 0 dBm level at input.
Fig 19. Test circuit for measuring isolation (OFF-state)

a. Test circuit

b. Input and output pulse definitions

Fig 20. Test circuit for measuring crosstalk voltage between digital inputs and switch

a. Test circuit

$\mathrm{V}_{\mathrm{O}}$

b. Input and output pulse definitions

Definition: $\mathrm{Q}_{\mathrm{inj}}=\Delta \mathrm{V}_{\mathrm{O}} \times \mathrm{C}_{\mathrm{L}}$.
$\Delta \mathrm{V}_{\mathrm{O}}=$ output voltage variation.
$\mathrm{R}_{\text {gen }}=$ generator resistance.
$\mathrm{V}_{\text {gen }}=$ generator voltage.
Fig 21. Test circuit for measuring charge injection

## 12. Package outline



Dimensions (mm are the original dimensions)

| Unit |  | $\mathrm{A}^{(1)}$ | $\mathrm{A}_{1}$ | b | D | E | e | $\mathrm{e}_{1}$ | L |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | $\mathrm{~L}_{1}$.

Notes

1. Including plating thickness.
2. Can be visible in some manufacturing processes.
sot886_po


Fig 22. Package outline SOT886 (XSON6)

## 13. Abbreviations

Table 13. Abbreviations

| Acronym | Description |
| :--- | :--- |
| CDM | Charged Device Model |
| CMOS | Complementary Metal-Oxide Semiconductor |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MM | Machine Model |
| PDA | Personal Digital Assistant |

## 14. Revision history

Table 14. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| :---: | :---: | :---: | :---: | :---: |
| NX3L1T5157 v.6.2 | 20191203 | Product data sheet | - | NX3L1T5157 v.6.1 |
| Modifications: | - Package SOT886 requiring SSB added. Refer to PCN number 201909001 XSON6 (SOT886) Assembly/Test Transfer from ATGD and ATSN to ATBK |  |  |  |
| NX3L1T5157 v.6.1 | 20161130 | Product data sheet | - | NX3L1T5157 v. 6 |
| Modifications: | - Added Section 13 "Packing information" |  |  |  |
| NX3L1T5157 v. 6 | 20111108 | Product data sheet | - | NX3L1T5157 v. 5 |
| Modifications: | - Legal pages updated. |  |  |  |
| NX3L1T5157 v. 5 | 20110728 | Product data sheet | - | NX3L1T5157 v. 4 |
| NX3L1T5157 v. 4 | 20100324 | Product data sheet | - | NX3L1T5157 v. 3 |
| NX3L1T5157 v. 3 | 20100208 | Product data sheet | - | NX3L1T5157 v. 2 |
| NX3L1T5157 v. 2 | 20090417 | Product data sheet | - | NX3L1T5157 v. 1 |
| NX3L1T5157 v.1 | 20080916 | Product data sheet | - | - |

## 15. Legal information

### 15.1 Data sheet status

| Document $\operatorname{status} \underline{[1][2]}$ | Product status $\underline{[3]}$ | Definition |
| :--- | :--- | :--- |
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
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